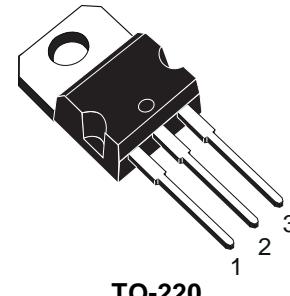


**STP22NF03L****N-CHANNEL 30V - 0.038Ω - 22A TO-220
STripFET™ POWER MOSFET**

| TYPE | V _{DSS} | R _{D(on)} | I _D |
|------------|------------------|--------------------|----------------|
| STP22NF03L | 30V | <0.05Ω | 22A |

- TYPICAL R_{D(on)} = 0.038Ω
- EXCEPTIONAL dv/dt CAPABILITY
- LOW GATE CHARGE AT 100°C
- APPLICATION ORIENTED CHARACTERIZATION



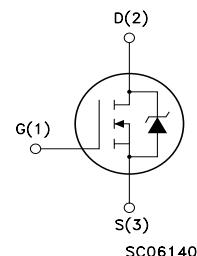
DESCRIPTION

This Power Mosfet is the latest development of STMicroelectronics unique "Single Feature Size™" strip-based process. The resulting transistor shows extremely high packing density for low on-resistance, rugged avalanche characteristics and less critical alignment steps therefore a remarkable manufacturing reproducibility.

APPLICATIONS

- DC-DC & DC-AC CONVERTERS
- MOTOR CONTROL, AUDIO AMPLIFIERS
- HIGH CURRENT, HIGH SPEED SWITCHING
- SOLENOID AND RELAY DRIVERS
- AUTOMOTIVE ENVIRONMENT

INTERNAL SCHEMATIC DIAGRAM



ABSOLUTE MAXIMUM RATINGS

| Symbol | Parameter | Value | Unit |
|---------------------|---|------------|------|
| V _{DS} | Drain-source Voltage (V _{GS} = 0) | 30 | V |
| V _{DGR} | Drain-gate Voltage (R _{GS} = 20 kΩ) | 30 | V |
| V _{GS} | Gate- source Voltage | ±15 | V |
| I _D | Drain Current (continuos) at T _C = 25°C | 22 | A |
| I _D | Drain Current (continuos) at T _C = 100°C | 16 | A |
| I _{DM (●)} | Drain Current (pulsed) | 88 | A |
| P _{TOT} | Total Dissipation at T _C = 25°C | 45 | W |
| | Derating Factor | 0.3 | W/°C |
| dv/dt (1) | Peak Diode Recovery voltage slope | 6 | V/ns |
| E _{AS} (2) | Single Pulse Avalanche Energy | 200 | mJ |
| T _{stg} | Storage Temperature | -65 to 175 | °C |
| T _j | Max. Operating Junction Temperature | 175 | °C |

(●) Pulse width limited by safe operating area

(1) I_{SD} ≤ 10A, di/dt ≤ 300A/μs, V_{DD} ≤ V_{(BR)DSS}, T_j ≤ T_{JMAX}.

(2) Starting T_j=25°C, I_D=11A, V_{DD}=15V

STP22NF03L

THERMAL DATA

| | | | |
|----------------|--|------|------|
| Rthj-case | Thermal Resistance Junction-case Max | 3.33 | °C/W |
| Rthj-amb | Thermal Resistance Junction-ambient Max | 62.5 | °C/W |
| T _L | Maximum Lead Temperature For Soldering Purpose | 300 | °C |

ELECTRICAL CHARACTERISTICS (TCASE = 25 °C UNLESS OTHERWISE SPECIFIED)

OFF

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|----------------------|---|---|------|------|---------|----------|
| V _{(BR)DSS} | Drain-source Breakdown Voltage | I _D = 250 µA, V _{GS} = 0 | 30 | | | V |
| I _{DSS} | Zero Gate Voltage Drain Current (V _{GS} = 0) | V _{DS} = Max Rating V _{DS} = Max Rating, T _C = 125 °C | | | 1 10 | µA µA |
| I _{GSS} | Gate-body Leakage Current (V _{DS} = 0) | V _{GS} = ±20V | | | ±100 | nA |

ON (1)

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|---------------------|-----------------------------------|--|------|----------------|--------------|------|
| V _{GS(th)} | Gate Threshold Voltage | V _{DS} = V _{GS} , I _D = 250µA | 1 | | | V |
| R _{D(on)} | Static Drain-source On Resistance | V _{GS} = 10V, I _D = 11 A V _{GS} = 5 V, I _D = 11 A | | 0.038 0.045 | 0.05 0.06 | Ω |
| I _{D(on)} | On State Drain Current | V _{DS} > I _{D(on)} × R _{D(on)max} , V _{GS} = 10V | 22 | | | A |

DYNAMIC

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|--|---|--|------|-----------------|------|----------------|
| g _{fs} (1) | Forward Transconductance | V _{DS} > I _{D(on)} × R _{D(on)max} , I _D = 11A | | 7 | | S |
| C _{iss} C _{oss} C _{rss} | Input Capacitance Output Capacitance Reverse Transfer Capacitance | V _{DS} = 25V, f = 1 MHz, V _{GS} = 0 | | 330 90 40 | | pF pF pF |

ELECTRICAL CHARACTERISTICS (CONTINUED)**SWITCHING ON**

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|-------------|--------------------|---|------|------|------|------|
| $t_{d(on)}$ | Turn-on Delay Time | $V_{DD} = 15V, I_D = 11A$ $R_G = 4.7\Omega, V_{GS} = 4.5V$ (see test circuit, Figure 3) | | 11 | | ns |
| t_r | Rise Time | | | 100 | | ns |
| Q_g | Total Gate Charge | $V_{DD} = 24V, I_D = 22A,$ $V_{GS} = 10V$ | | 6.5 | 9 | nC |
| Q_{gs} | Gate-Source Charge | | | 3.6 | | nC |
| Q_{gd} | Gate-Drain Charge | | | 2 | | nC |

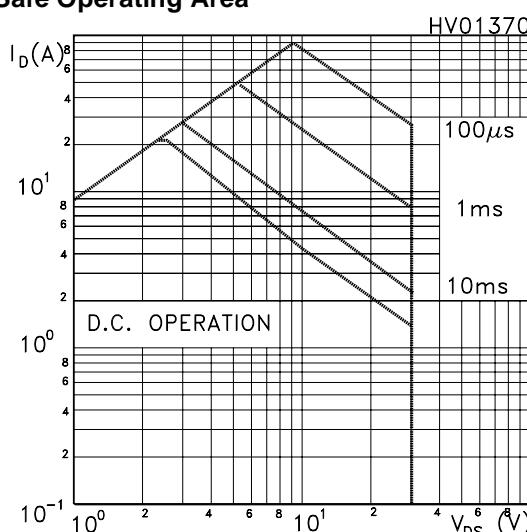
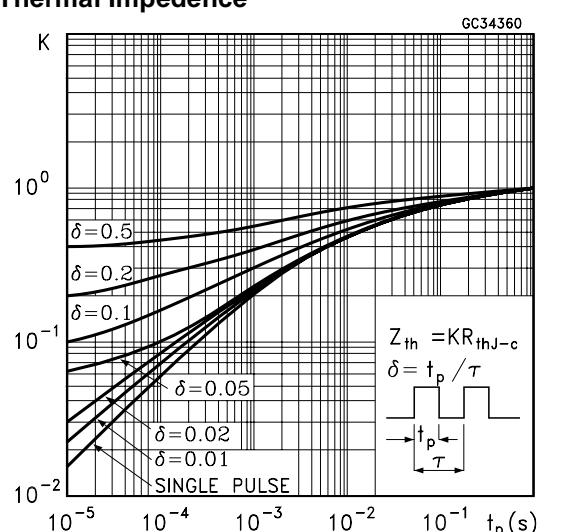
SWITCHING OFF

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|--------------|-----------------------|--|------|------|------|------|
| $t_{d(off)}$ | Turn-off-Delay Time | $V_{DD} = 15V, I_D = 11A,$ $R_G = 4.7\Omega, V_{GS} = 4.5V$ (see test circuit, Figure 3) | | 25 | | ns |
| t_f | Fall Time | | | 22 | | ns |
| $t_{r(off)}$ | Off-voltage Rise Time | $V_{clamp} = 24V, I_D = 22A$ $R_G = 4.7\Omega, V_{GS} = 4.5V$ | | 22 | | ns |
| t_f | Fall Time | (see test circuit, Figure 5) | | 55 | | ns |
| t_c | Cross-over Time | | | 75 | | ns |

SOURCE DRAIN DIODE

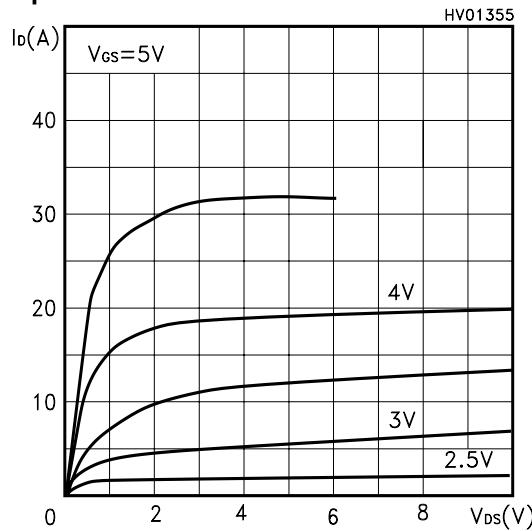
| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|--------------|-------------------------------|---|------|------|------|------|
| I_{SD} | Source-drain Current | | | | 22 | A |
| $I_{SDM}(1)$ | Source-drain Current (pulsed) | | | | 88 | A |
| $V_{SD}(2)$ | Forward On Voltage | $I_{SD} = 22A, V_{GS} = 0$ | | | 1.5 | V |
| t_{rr} | Reverse Recovery Time | $I_{SD} = 22A, dI/dt = 100A/\mu s$, $V_{DD} = 15V, T_j = 150^\circ C$ (see test circuit, Figure 5) | | 30 | | ns |
| Q_{rr} | Reverse Recovery Charge | | | 18 | | nC |
| I_{RRM} | Reverse Recovery Current | | | 1.2 | | A |

Note: 1. Pulsed: Pulse duration = 300 μs , duty cycle 1.5 %.
2. Pulse width limited by safe operating area.

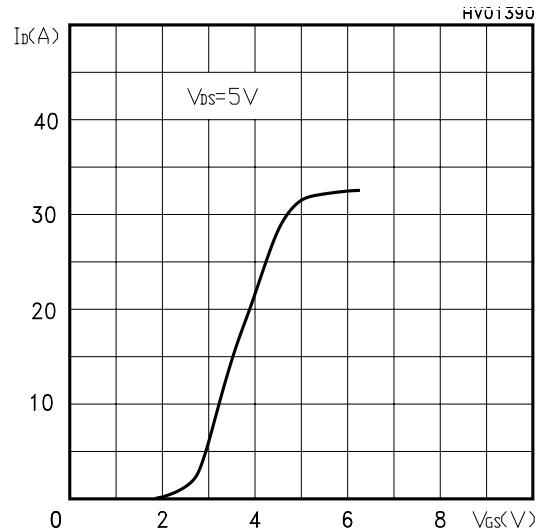
Safe Operating Area**Thermal Impedance**

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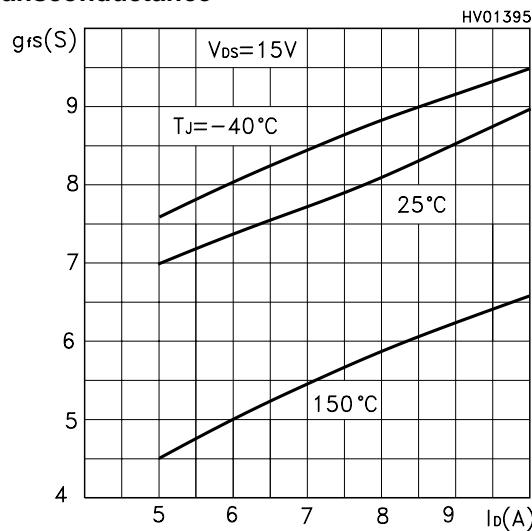
Output Characteristics



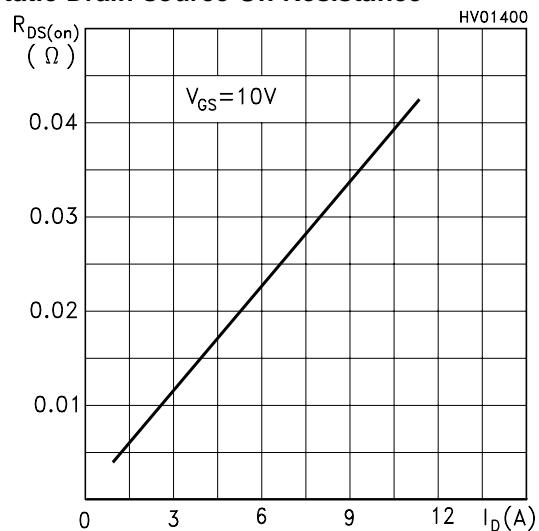
Transfer Characteristics



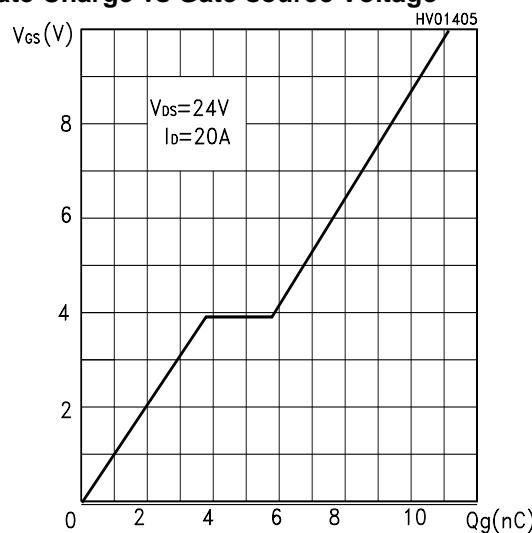
Transconductance



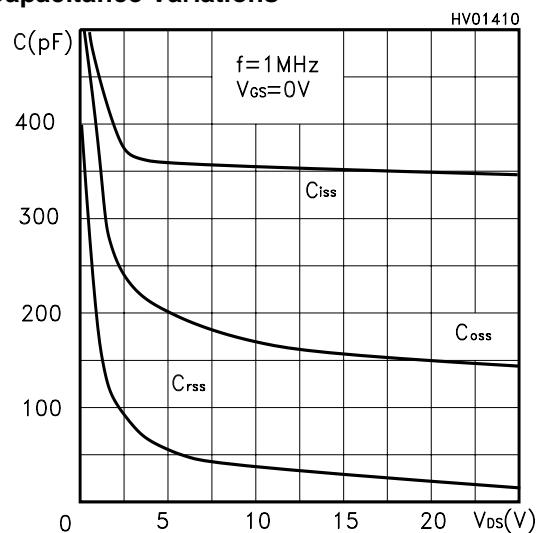
Static Drain-source On Resistance

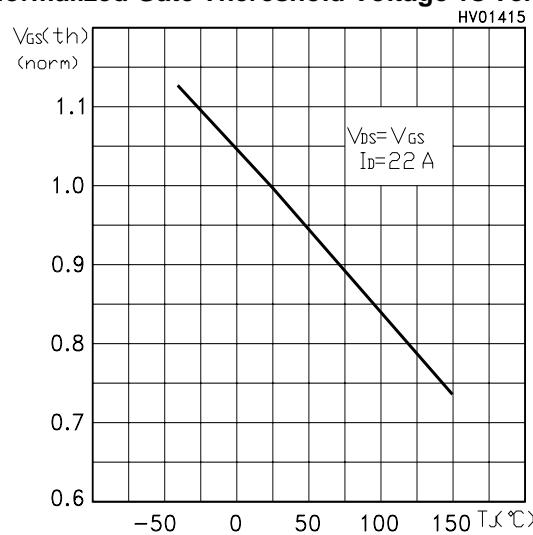
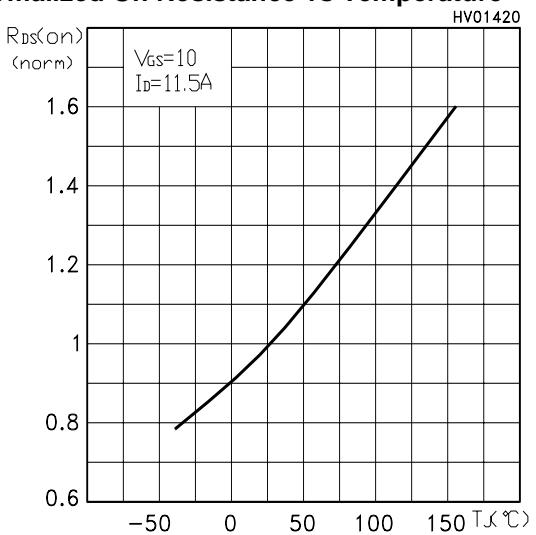
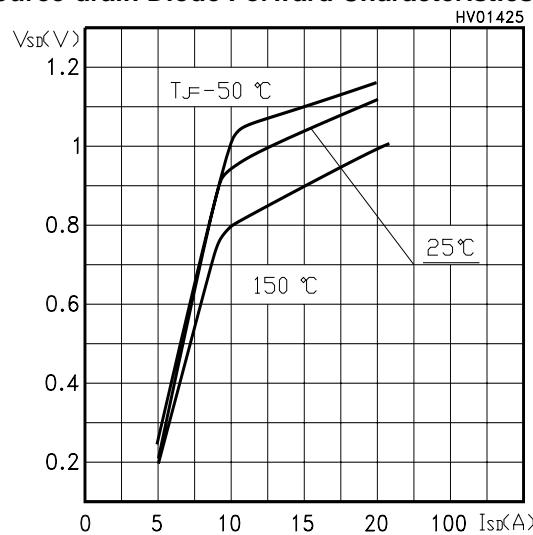


Gate Charge vs Gate-source Voltage



Capacitance Variations



Normalized Gate Threshold Voltage vs Temp.**Normalized On Resistance vs Temperature****Source-drain Diode Forward Characteristics**

STP22NF03L

Fig. 1: Unclamped Inductive Load Test Circuit

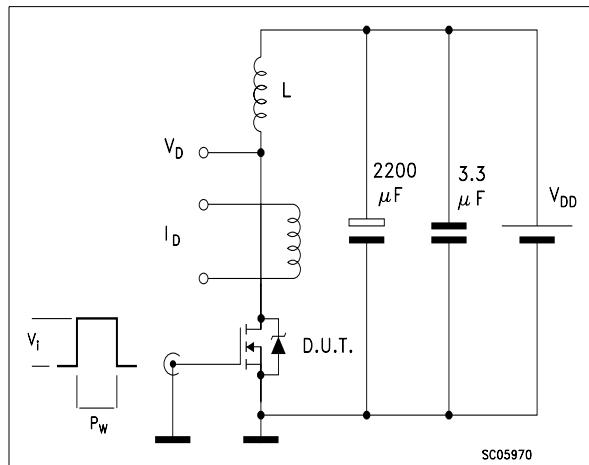


Fig. 2: Unclamped Inductive Waveform

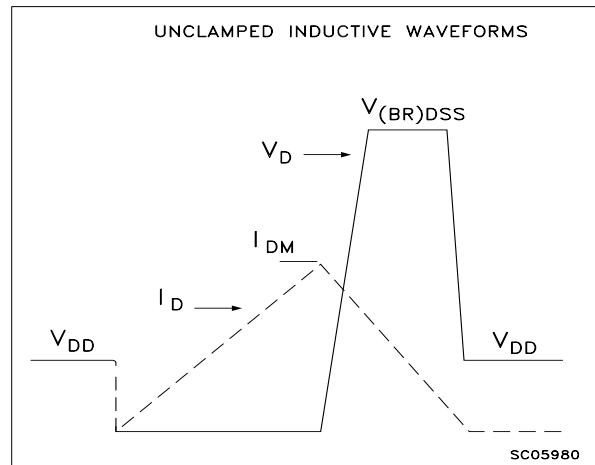


Fig. 3: Switching Times Test Circuit For Resistive Load

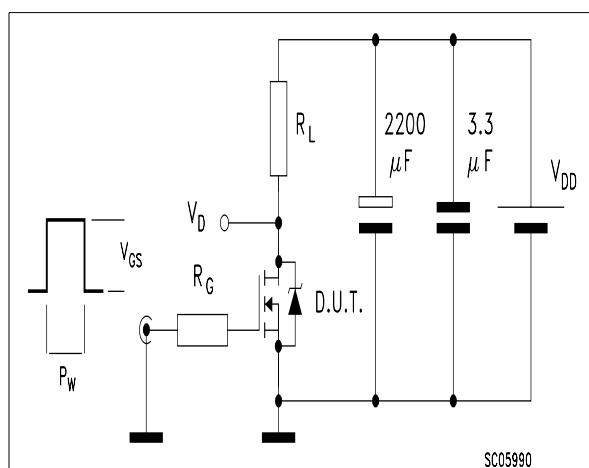


Fig. 4: Gate Charge test Circuit

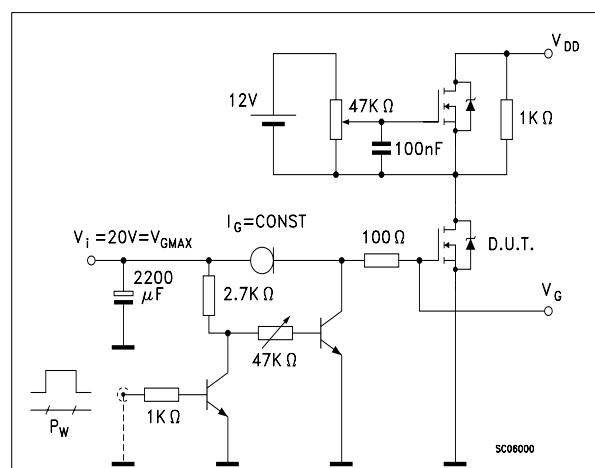
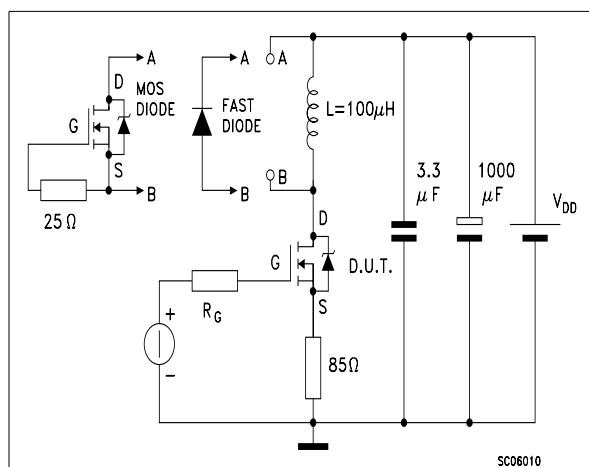
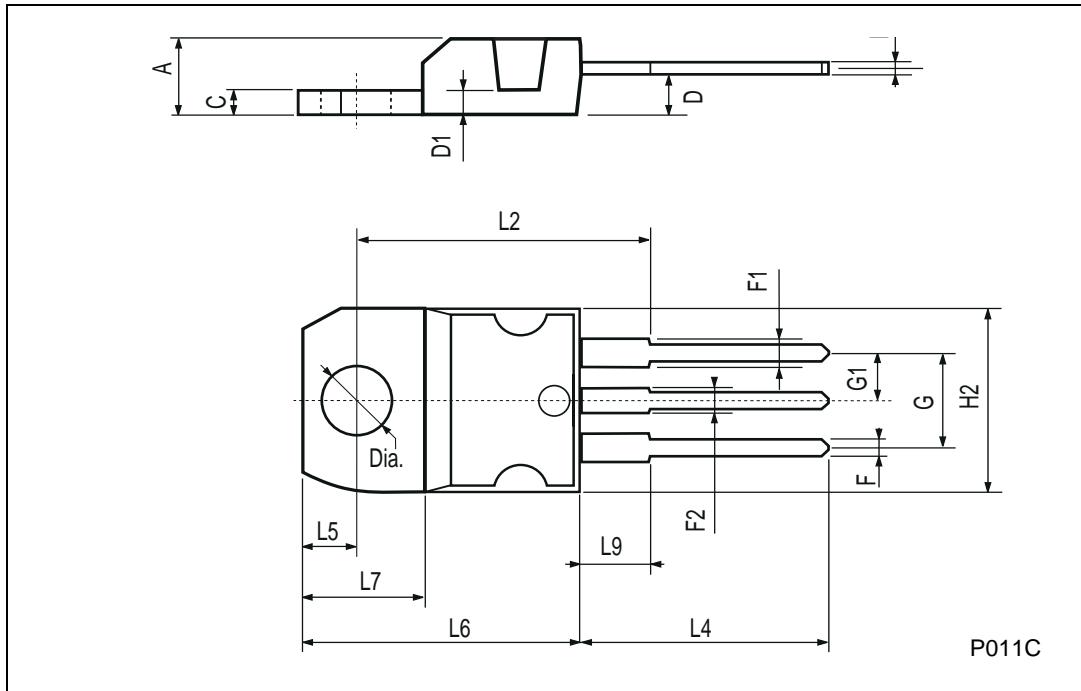


Fig. 5: Test Circuit For Inductive Load Switching And Diode Recovery Times



TO-220 MECHANICAL DATA

| DIM. | mm | | | inch | | |
|------|-------|------|-------|-------|-------|-------|
| | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. |
| A | 4.40 | | 4.60 | 0.173 | | 0.181 |
| C | 1.23 | | 1.32 | 0.048 | | 0.051 |
| D | 2.40 | | 2.72 | 0.094 | | 0.107 |
| D1 | | 1.27 | | | 0.050 | |
| E | 0.49 | | 0.70 | 0.019 | | 0.027 |
| F | 0.61 | | 0.88 | 0.024 | | 0.034 |
| F1 | 1.14 | | 1.70 | 0.044 | | 0.067 |
| F2 | 1.14 | | 1.70 | 0.044 | | 0.067 |
| G | 4.95 | | 5.15 | 0.194 | | 0.203 |
| G1 | 2.4 | | 2.7 | 0.094 | | 0.106 |
| H2 | 10.0 | | 10.40 | 0.393 | | 0.409 |
| L2 | | 16.4 | | | 0.645 | |
| L4 | 13.0 | | 14.0 | 0.511 | | 0.551 |
| L5 | 2.65 | | 2.95 | 0.104 | | 0.116 |
| L6 | 15.25 | | 15.75 | 0.600 | | 0.620 |
| L7 | 6.2 | | 6.6 | 0.244 | | 0.260 |
| L9 | 3.5 | | 3.93 | 0.137 | | 0.154 |
| DIA. | 3.75 | | 3.85 | 0.147 | | 0.151 |



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